16-bit transceiver with direction pin; 3.6 V tolerant; 3-stateRev. 3 — 31 January 2013Product data s

Product data sheet

#### 1. **General description**

The 74AVC16245 is a 16-bit transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable inputs (nOE) for easy cascading and two send/receive inputs (nDIR) for direction control. Inputs nOE control the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74AVC16245 is designed to have an extremely fast propagation delay and a minimum amount of power consumption.

To ensure the high-impedance output state during power-up or power-down, tie pins nOE to V<sub>CC</sub> through a pull-up resistor (Live Insertion).

A Dynamic Controlled Output (DCO) circuitry is implemented to support termination line drive during transient (see Figure 4 and Figure 5)

#### Features and benefits 2.

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standards:
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-1A (2.7 V to 3.6 V)
- CMOS low power consumption
- Input/output tolerant up to 3.6 V
- Dynamic Controlled Output (DCO) circuit dynamically changes output impedance, resulting in noise reduction without speed degradation
- Low inductance multiple VCC and GND pins to minimize noise and ground bounce
- Supports Live Insertion

#### Ordering information 3.

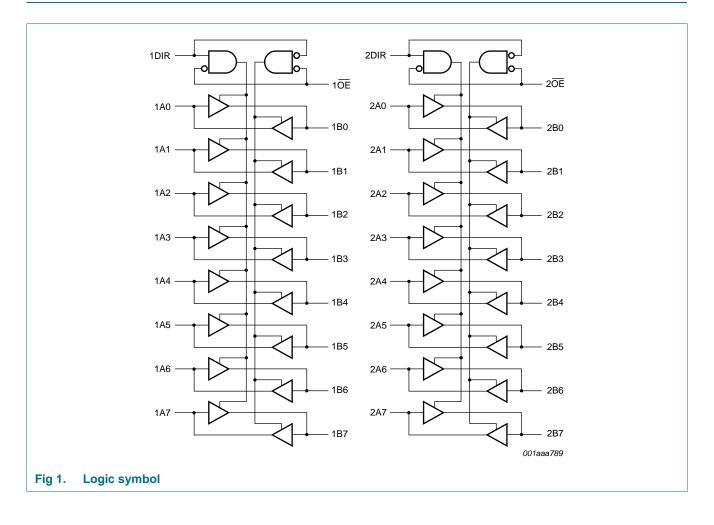
#### Table 1. **Ordering information**

Type number	Package				
	Temperature range	Name	Description	Version	
74AVC16245DGG	–40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1	



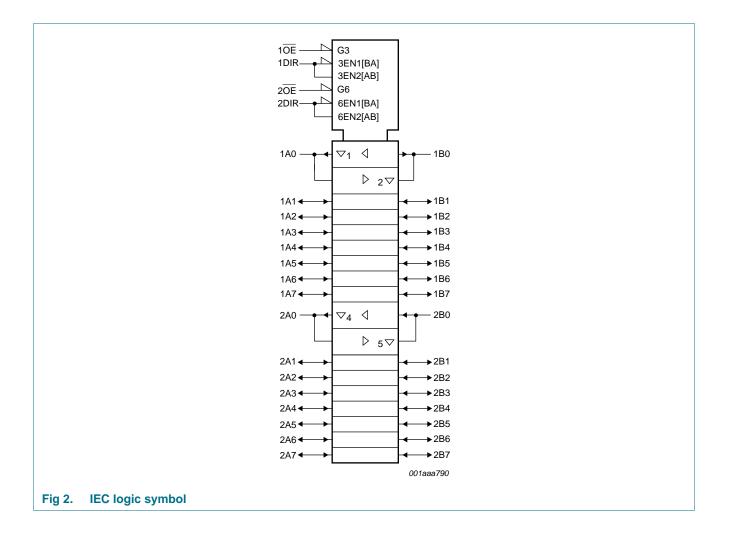
16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

### 4. Functional diagram



## 74AVC16245

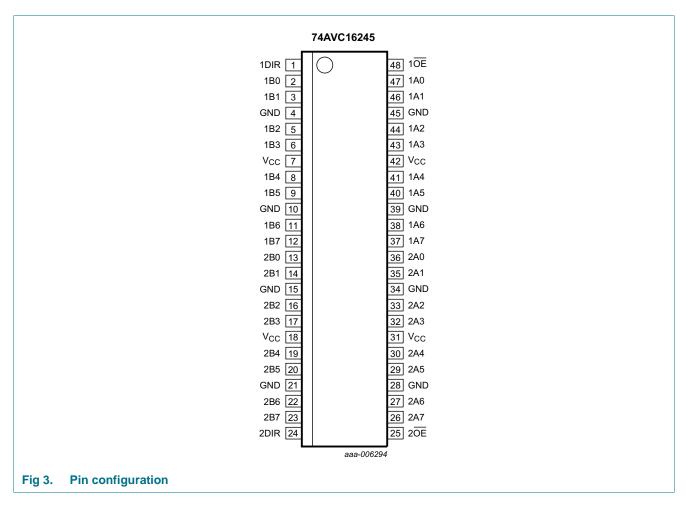
#### 16-bit transceiver with direction pin; 3.6 V tolerant; 3-state



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

### 5. Pinning information

### 5.1 Pinning



16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

### 5.2 Pin description

Table 2. Pin	description	
Symbol	Pin	Description
1DIR, 2DIR	1, 24	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	data input/output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V <sub>CC</sub>	7, 18, 31, 42	supply voltage
1 <u>0E</u> , 2 <u>0E</u>	48, 25	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	data input/output

### 6. Functional description

Table 3.	Function table <sup>[1]</sup>			
Inputs		Outputs		
nOE	nDIR	nAn	nBn	
L	L	A = B	inputs	
L	Н	inputs	B = A	
Н	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

### 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	output HIGH or LOW	<u>[1]</u> –0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	<u>[1]</u> –0.5	+4.6	V
I <sub>O</sub>	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 60 °C, the value of  $P_{tot}$  derates linearly with 5.5 mW/K.

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### 8. Recommended operating conditions

Table 5.	Recommended operating	conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	according to JEDEC Low Voltage Standards	1.4	-	1.6	V
			1.65	-	1.95	V
			2.3	-	2.7	V
			3.0	-	3.6	V
		for low-voltage applications	1.2	-	3.6	V
VI	input voltage		0	-	3.6	V
Vo	output voltage	output HIGH or LOW	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	3.6	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
$\Delta t / \Delta V$	input transition rise and fall	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	0	-	40	ns/V
	rate	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0	-	30	ns/V
		$V_{CC} = 2.3 \text{ V to } 3.0 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.2 V	V <sub>CC</sub>	-	-	V
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	$0.65 \times V_{CC}$	0.9	-	V
		$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	0.9	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	1.2	-	V
		$V_{CC}$ = 3.0 V to 3.6 V	2.0	1.5	-	V
V <sub>IL</sub> I	LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	GND	V
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	0.9	$0.35 \times V_{CC}$	V
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	0.9	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	1.2	0.7	V
		$V_{CC}$ = 3.0 V to 3.6 V	-	1.5	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = –100 $\mu\text{A};$ $V_{CC}$ = 1.65 V to 3.6 V	$V_{CC}-0.20$	V <sub>CC</sub>	-	V
		$I_{O} = -3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	$V_{CC}-0.35$	$V_{CC}-0.21$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	$V_{CC}-0.45$	$V_{CC}-0.25$	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.55$	$V_{CC}-0.37$	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC}-0.70$	$V_{CC}-0.47$	-	V

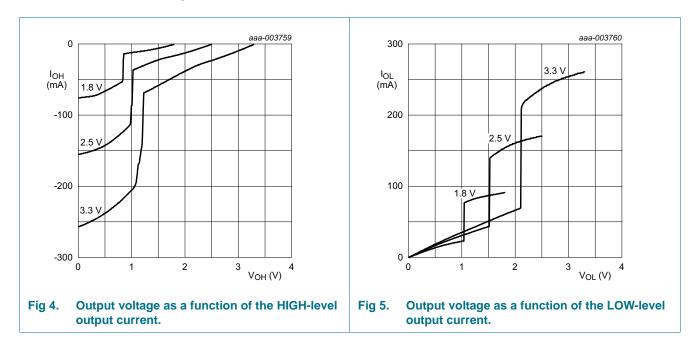
## 74AVC16245

#### 16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

At recom	mended operating conditions	s. Voltages are referenced to GND (ground	= 0 V).			
Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 100 $\mu A;$ $V_{CC}$ = 1.65 V to 3.6 V	-	GND	0.20	V
		$I_0 = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	0.22	0.35	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.24	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.38	0.55	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.53	0.70	V
I <sub>I</sub>	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 1.4$ V to 3.6 V	-	0.1	2.5	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 3.6 \text{ V};  V_{CC} = 0.0 \text{ V}$	-	±0.1	±10	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$				
		$V_{CC}$ = 1.4 V to 2.7 V	-	0.1	5	μΑ
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.1	10	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A				
		$V_{CC}$ = 1.4 V to 2.7 V	-	0.1	20	μΑ
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	0.2	40	μΑ
CI	input capacitance		-	5.0	-	pF

#### Static characteristics ... continued Table 6.

[1] All typical values are measured at  $T_{amb}$  = 25 °C.



### 9.1 Graphs

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

### **10.** Dynamic characteristics

### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol				-40	0 °C to +85 °C		Unit
				Min	Typ <sup>[2]</sup>	Max	
t <sub>pd</sub>	propagation delay	nAn to nBn; nBn to nAn; see Figure 6	<u>[1]</u>				
		$V_{CC} = 1.2 V$		-	2.8	-	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	1.8	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		0.7	1.8	3.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.6	1.3	1.9	ns
		$V_{CC}$ = 3.0 V to 3.6 V		0.5	1.1	1.7	ns
t <sub>en</sub>	enable time	nOE to nAn, nBn; see Figure 7	<u>[1]</u>				
		$V_{CC} = 1.2 V$		-	5.9	-	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	3.9	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.4	3.3	6.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.4	4.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.7	2.0	3.7	ns
t <sub>dis</sub>	disable time	nOE to nAn, nBn; see Figure 7	<u>[1]</u>				
		$V_{CC} = 1.2 V$		-	6.9	-	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	4.8	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.2	3.7	6.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.1	2.0	4.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.2	2.2	3.7	ns
C <sub>PD</sub>	power dissipation	per input; $V_I = GND$ to $V_{CC}$	[3]				
	capacitance	outputs enabled		-	42	-	pF
		outputs disabled		-	2	-	pF

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[2] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

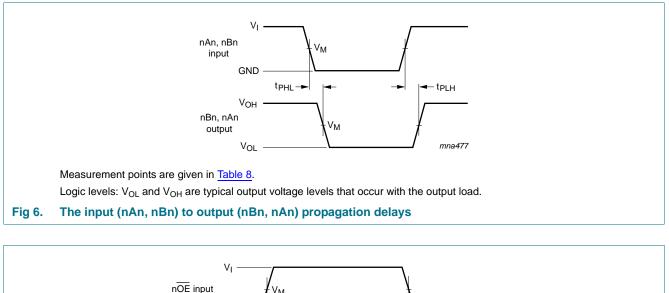
V<sub>CC</sub> = supply voltage in Volts

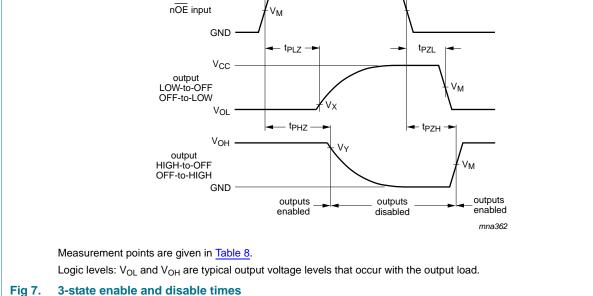
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

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### 11. Waveforms





#### Table 8.Measurement points

Supply voltage	V <sub>M</sub>	Input	Input				
V <sub>CC</sub>		VI	$t_r = t_f$	V <sub>X</sub>	V <sub>Y</sub>		
1.2 V	$0.5\times V_{CC}$	V <sub>CC</sub>	$\leq$ 2 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V		
1.4 V to 1.6 V	$0.5\times V_{CC}$	V <sub>CC</sub>	$\leq$ 2 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V		
1.65 V to 1.95 V	$0.5\times V_{CC}$	V <sub>CC</sub>	$\leq$ 2 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V		
2.3 V to 2.7 V	$0.5\times V_{CC}$	V <sub>CC</sub>	$\leq$ 2 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V		
3.0 V to 3.6 V	$0.5\times V_{CC}$	V <sub>CC</sub>	$\leq$ 2 ns	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$		

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#### 16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

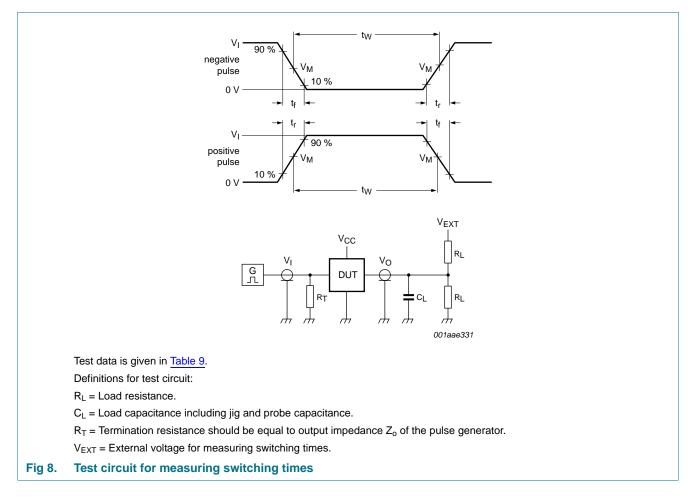


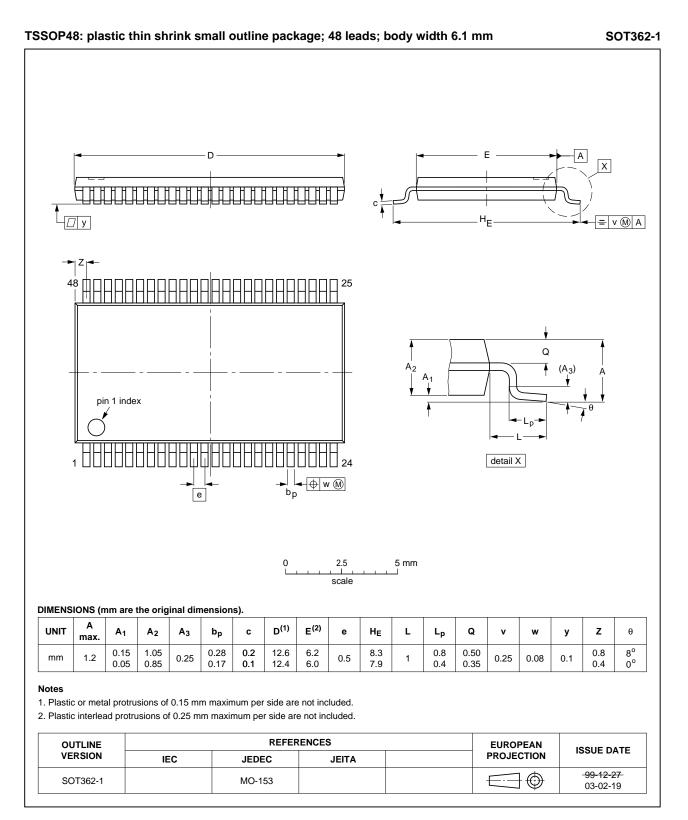
Table	9.	Test	data

Supply voltage	Input	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	15 pF	2 kΩ	open	$2 \times V_{CC}$	GND	
1.4 V to 1.6 V	V <sub>CC</sub>	$\leq$ 2 ns	15 pF	2 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
3.0 V to 3.6 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	

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### 12. Package outline



#### Fig 9. Package outline SOT362-1 (TSSOP48)

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16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

### 13. Abbreviations

AcronymDescriptionCMOSComplementary Metal-Oxide SemiconductorDUTDevice Under Test	Table 10.	Abbreviations
	Acronym	Description
DUT Device Under Test	CMOS	Complementary Metal-Oxide Semiconductor
	DUT	Device Under Test
TTL Transistor-Transistor Logic	TTL	Transistor-Transistor Logic

### 14. Revision history

#### Table 11.Revision history

Document ID	Release date	e Data sheet status	Change notice	Order number	Supersedes		
74AVC16245 v.3	20130131	Product data sheet	-	-	74AVC16245 v.2		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>						
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
74AVC16245 v.2	19991115	Product specification	-	-	74AVC16245 v.1		
74AVC16245 v.1	19981211	Product specification	-	-	-		

### **15. Legal information**

### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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#### 16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

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### 74AVC16245

16-bit transceiver with direction pin; 3.6 V tolerant; 3-state

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